(V) Preliminary Specification
( ) Final Specification

Module	**24" Color TFT-LCD**
Model Name	**M240HVN02.0**

Customer	Date	Approved by	Date
		Howard Lee	Jan 22, 2013
Approved by		**Prepared by**	**Date**
		CJ Huang	Jan 22, 2013
Note: This Specification is subject to change without notice.		AU Optronics corporation	

Contents

Record of Revision

Version	Date	Page	Old description	New Description	Remark
0.1	2012/12/24	All	First version release		
0.2	2013/01/05	P24	LED CNT: slim type	LED CNT: 3707K-S06N-21R	
0.3	2013/01/22	P27	Drop test: Height: 60 cm	Drop test: Height: 46 cm	

1 Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.
2) Be sure to turn off power supply when inserting or disconnecting from input connector.
3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
7) Do not open or modify the Module Assembly.
8) Do not press the reflector sheet at the back of the module to any directions.
9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
12) Please avoid touching COF position while you are doing mechanical design.
13) When storing modules as spares for a long time, the following precaution is necessary:
Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5℃ and 35℃ at normal humidity.

2 General Description

This specification applies to the 24 inch wide Color a-Si TFT-LCD Module M240HVN02.0. The display supports the Full HD - 1920(H) x 1080(V) screen format and 16.7M colors (RGB 8-bit data). The input interface is Dual channel LVDS and this module doesn't contain an driver board for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25□ condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	**609.6 (24.0")**
Active Area	[mm]	**531.36 (H) x 298.89 (V)**
Pixels H x V	-	**1920(x3) x 1080**
Pixel Pitch	[um]	**276.75 (per one triad) ×276.75**
Pixel Arrangement	-	**R.G.B. Vertical Stripe**
Display Mode	-	**VA Mode, Normally Black**
White Luminance (Center)	[cd/m^2]	**250 (Typ.)**
Contrast Ratio	-	**3000 (Typ.)**
Response Time	[msec]	**12(Typ., on/off)**
Power Consumption (LCD Module + Backligh unit)	[Watt]	**19.9 (typ)** **VDD line : PDD (typ), All white pattern at 60Hz =5.5** **LED line : PBLU (typ) = 14.4**
Weight	[Grams]	**1625 (Typ.)**
Outline Dimension	[mm]	**544.8 (H) x 318.6 (V) x 9.5 (D) (Typ.)**
Electrical Interface	-	**Dual channel LVDS**
Support Color	-	**16.7M colors (RGB 8-bit)**
Surface Treatment	-	**Anti-Glare, 3H**
Temperature Range Operating Storage (Shipping)	 [°C] [°C]	 **0 to +50** **-20 to +60**
RoHS Compliance	-	**RoHS Compliance**
TCO Compliance	-	**TCO 6.0 Compliance**

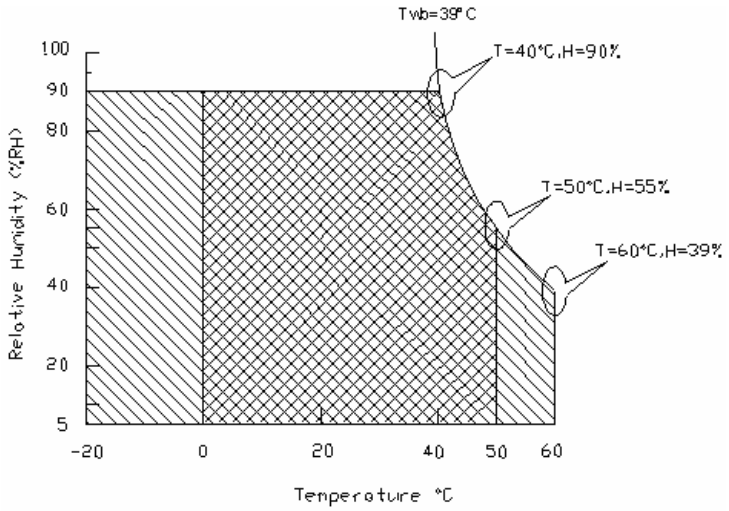
2.2 Absolute Maximum Rating of Environment

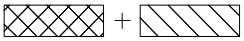
Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min.	Max.	Unit	Remark
TOP	Operating Temperature	0	+50	[°C]	***Note 2-1***
TGS	Glass surface temperature (operation)	0	+65	[°C]	***Note 2-1*** *Function judged only*
HOP	Operation Humidity	5	90	[%RH]	***Note 2-1***
TST	Storage Temperature	-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

1. 90% RH Max (Ta ≦39℃)
2. Max wet-bulb temperature at 39℃ or less. (Ta ≦39℃)
3. No condensation



Operating Range  Storage Range 

2.3 Optical Characteristics

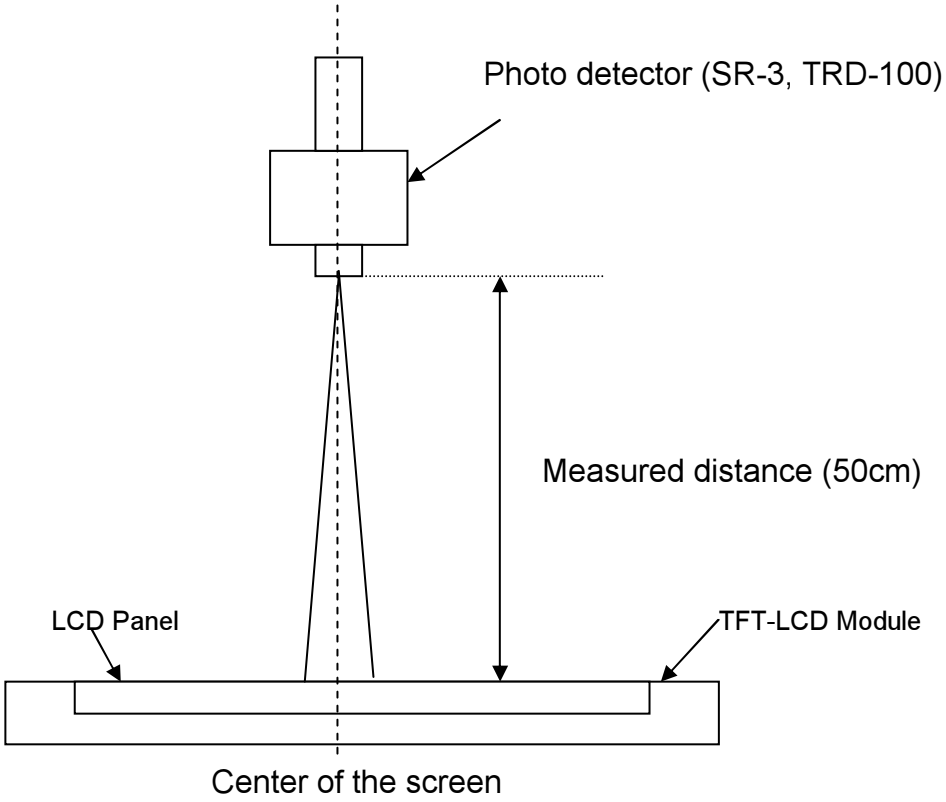
The optical characteristics are measured on the following test condition.

Test Condition:

1. Equipment setup: Please refer to ***Note 2-2***.
2. Panel Lighting time: 30 minutes
3. VDD=5.0V, Fv=60Hz,Is=65mA,Ta=25℃

Symbol	Description		Min.	Typ.	Max.	Unit	Remark
L_w	White Luminance (Center of screen)		200	250	-	[cd/m2]	***Note 2-2*** *By SR-3*
L_{uni}	Luminance Uniformity (9 points)		75	80	-	[%]	***Note 2-3*** *By SR-3*
CR	Contrast Ratio (Center of screen)		1800	3000	-	-	***Note 2-4*** *By SR-3*
θ_R	Horizontal Viewing Angle (CR=10)	Right	75	89	-	[degree]	***Note 2-5*** *By SR-3*
θ_L		Left	75	89	-		
Φ_H	Vertical Viewing Angle (CR=10)	Up	75	89	-		
Φ_L		Down	75	89	-		
θ_R	Horizontal Viewing Angle (CR=5)	Right	75	89	-		
θ_L		Left	75	89	-		
Φ_H	Vertical Viewing Angle (CR=5)	Up	75	89	-		
Φ_L		Down	75	89	-		
T_R	Response Time	Rising Time	-	7	-	[msec]	***Note 2-6*** *By TRD-100*
T_F		Falling Time	-	5	-		
-		Rising + Falling	-	12	-		
R_x	Color Coordinates (CIE 1931)	Red x	0.611	0.641	0.671	-	*By SR-3*
R_y		Red y	0.305	0.335	0.365		
G_x		Green x	0.294	0.324	0.354		
G_y		Green y	0.591	0.621	0.651		
B_x		Blue x	0.124	0.154	0.184		
B_y		Blue y	0.023	0.053	0.083		
W_x		White x	0.283	0.313	0.343		
W_y		White y	0.299	0.329	0.359		
CT	Crosstalk		-	-	1.5	[%]	***Note 2-7*** *By SR-3*
F_{dB}	Flicker (Center of screen)		-	-	-20	[dB]	***Note 2-8*** *By SR-3*

Note 2-2: Equipment setup :

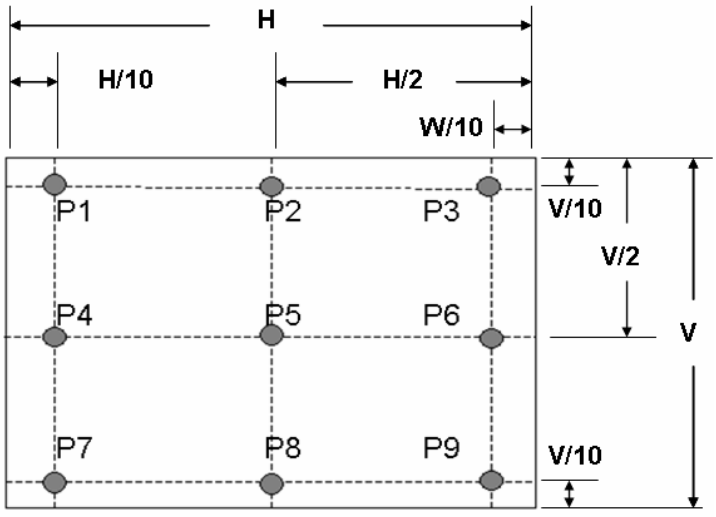


Note 2-3: Luminance Uniformity Measurement

Definition:

$$\text{Luminance Uniformity} = \frac{\text{Minimum Luminance of 9 Points (P1 ~ P9)}}{\text{Maximum Luminance of 9 Points (P1 ~ P9)}}$$

a. Test pattern: White Pattern



Note 2-4: Contrast Ratio Measurement

Definition:

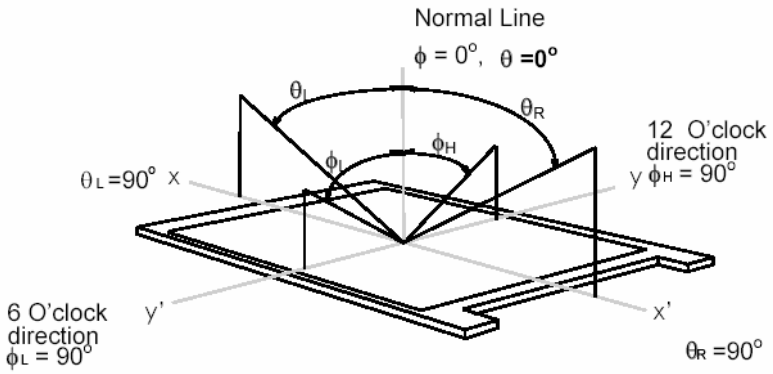
$$\text{Contrast Ratio} = \frac{\text{Luminance of White pattern}}{\text{Luminance of Black pattern}}$$

a. Measured position: Center of screen (P5) & perpendicular to the screen (θ=Φ=0°)

Note 2-5: Viewing angle measurement

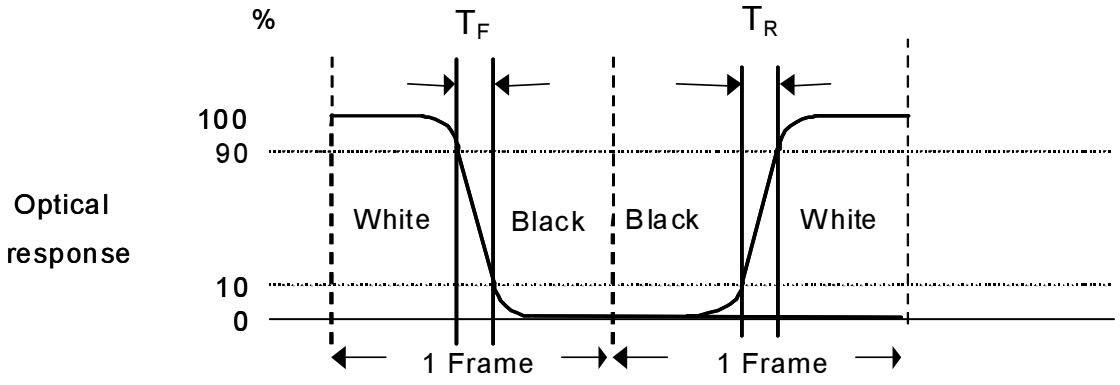
Definition: The angle at which the contrast ratio is greater than 10 & 5 .

a. Horizontal view angle: Divide to left & right (θ_L & θ_R)
Vertical view angle: Divide to up & down (Φ_H &Φ_L)



Note 2-6: Response time measurement

The output signals of photo detector are measured when the input signals are changed from "Black" to "White" (rising time, T_R), and from "White" to "Black" (falling time, T_F), respectively. The response time is interval between the 10% and 90% of optical response. (*Black & White color definition: Please refer section 3.4.3)*



Note 2-7: Crosstalk measurement

Definition:

$CT = Max. (CT_H, CT_V)$;

Where

a. Maximum Horizontal Crosstalk :

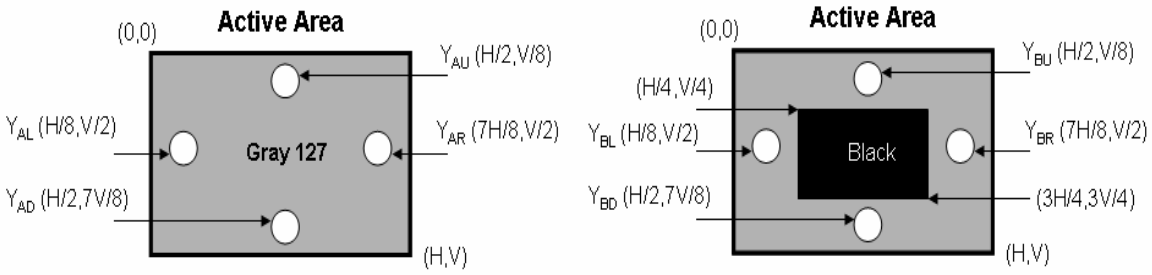
$CT_H = Max. (| Y_{BL} – Y_{AL} | / Y_{AL} \times 100\ \%, | Y_{BR} – Y_{AR} | / Y_{AR} \times 100\ \%)$;

Maximum Vertical Crosstalk:

$CT_V = Max. (| Y_{BU} – Y_{AU} | / Y_{AU} \times 100\ \%, | Y_{BD} – Y_{AD} | / Y_{AD} \times 100\ \%)$;

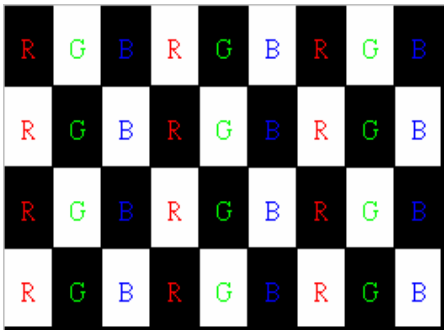
b. Y_{AU}, Y_{AD}, Y_{AL}, Y_{AR} = Luminance of measured location without Black pattern

Y_{BU}, Y_{BD}, Y_{BL}, Y_{BR} = Luminance of measured location with Black pattern



Note 2-8: Flicker measurement

a. Test pattern: It is listed as following.



Gray level = L0

Gray level = L127

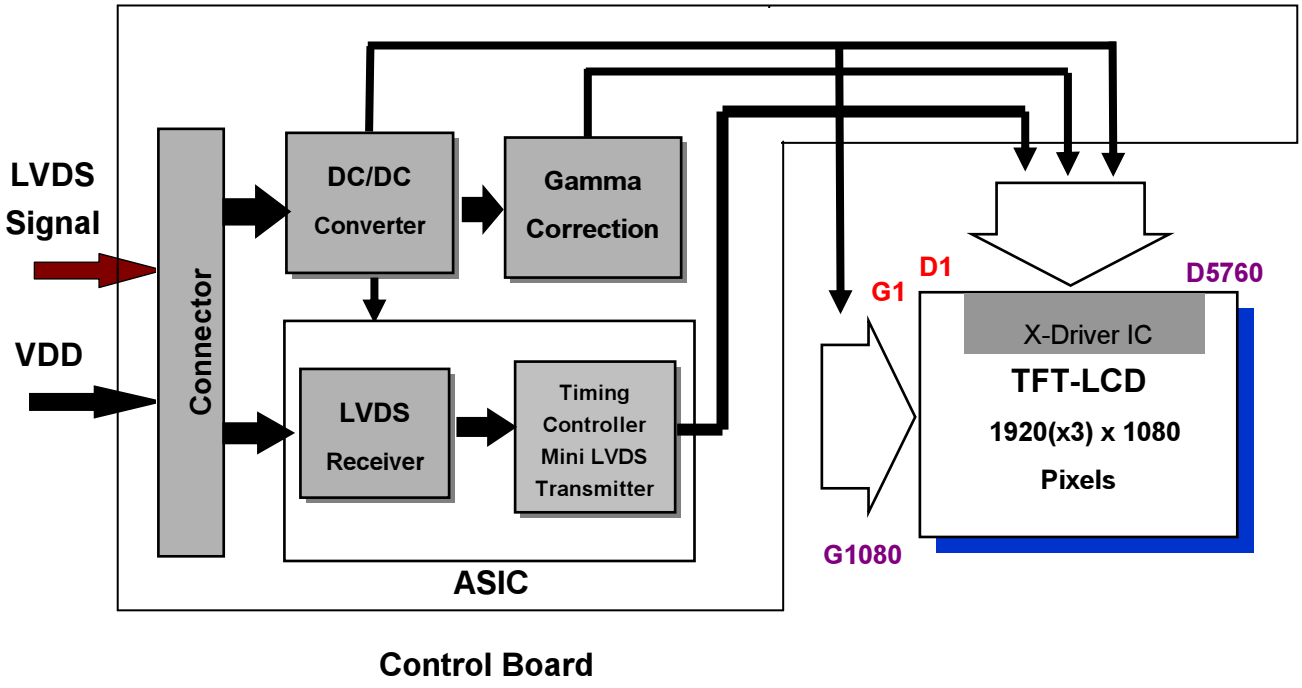
R: Red, G: Green, B:Blue

b. Measured position: Center of screen (P5) & perpendicular to the screen (θ=Φ=0°)

3 TFT-LCD Module

3.1 Block Diagram

The following shows the block diagram of the **24** inch Color TFT-LCD Module.



3.2 Interface Connection

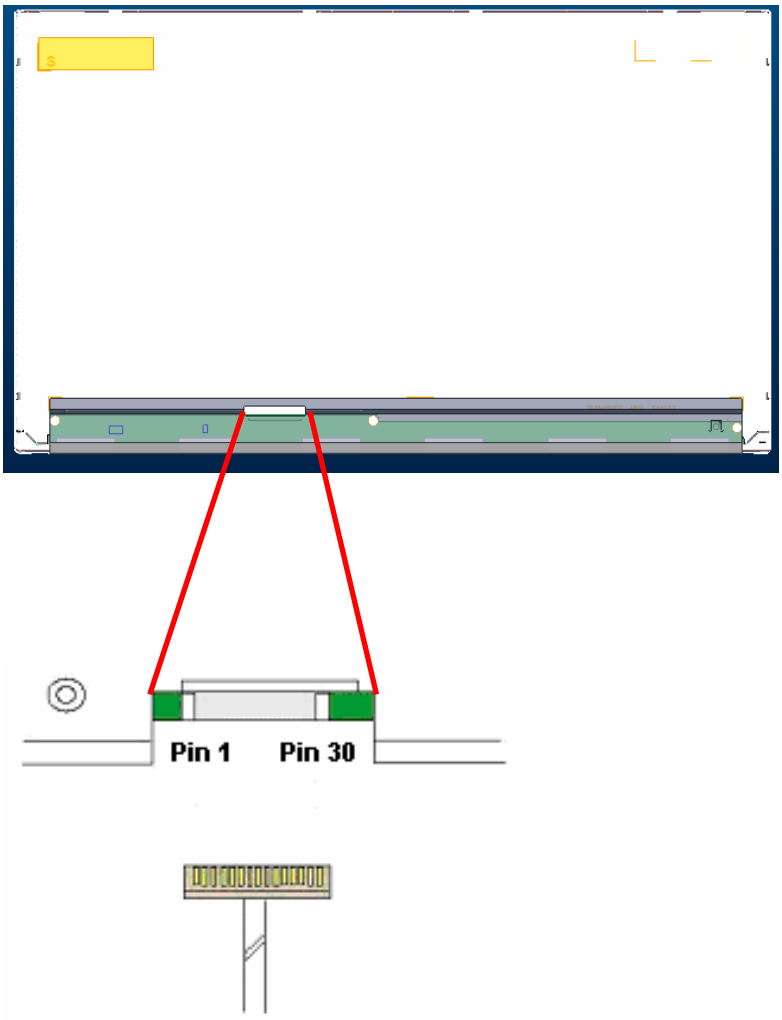
3.2.1 Connector Type

TFT-LCD Connector	Manufacturer	P-TWO	STM
	Part Number	AL230F-A0G1D-P	MSCKT2407P30HB
Mating Connector	Manufacturer	JAE	
	Part Number	FI-X30HL (Locked Type)	

3.2.2 Connector Pin Assignment

PIN #	Symbol	Description	Remark
1	RxO0-	Negative LVDS differential data input (Odd data)	
2	RxO0+	Positive LVDS differential data input (Odd data)	
3	RxO1-	Negative LVDS differential data input (Odd data)	
4	RxO1+	Positive LVDS differential data input (Odd data)	
5	RxO2-	Negative LVDS differential data input (Odd data)	
6	RxO2+	Positive LVDS differential data input (Odd data)	
7	GND	Power Ground	
8	RxOCLK-	Negative LVDS differential clock input (Odd clock)	
9	RxOCLK+	Positive LVDS differential clock input (Odd clock)	
10	RxO3-	Negative LVDS differential data input (Odd data)	
11	RxO3+	Positive LVDS differential data input (Odd data)	
12	RxE0-	Negative LVDS differential data input (Even data)	
13	RxE0+	Positive LVDS differential data input (Even data)	
14	GND	Power Ground	
15	RxE1-	Negative LVDS differential data input (Even data)	
16	RxE1+	Positive LVDS differential data input (Even data)	
17	GND	Power Ground	
18	RxE2-	Negative LVDS differential data input (Even data)	
19	RxE2+	Positive LVDS differential data input (Even data)	
20	RxECLK-	Negative LVDS differential clock input (Even clock)	
21	RxECLK+	Positive LVDS differential clock input (Even clock)	
22	RxE3-	Negative LVDS differential data input (Even data)	
23	RxE3+	Positive LVDS differential data input (Even data)	
24	GND	Power Ground	
25	NC	No connection (for AUO test only. Do not connect)	
26	NC	No connection (for AUO test only. Do not connect)	

27	NC	No connection (for AUO test only. Do not connect)	
28	VDD	Power Supply Input Voltage	
29	VDD	Power Supply Input Voltage	
30	VDD	Power Supply Input Voltage	



3.3 Electrical Characteristics

3.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

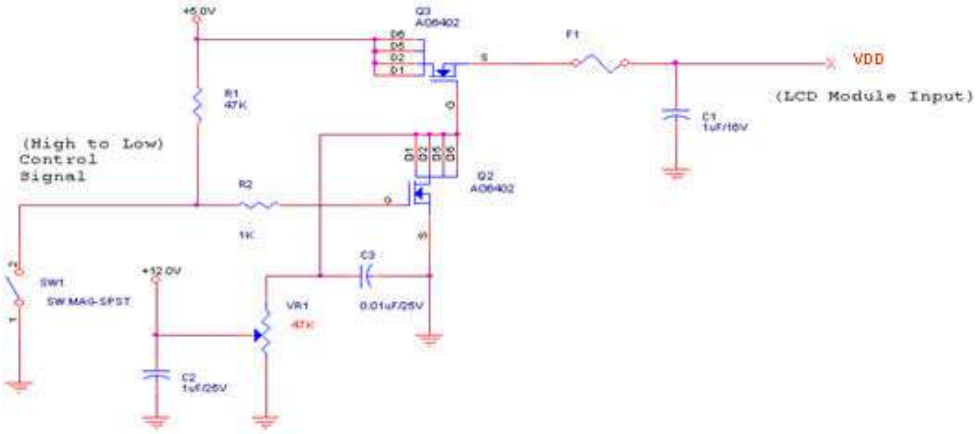
Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25□

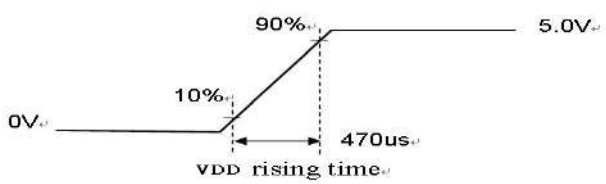
3.3.2 Recommended Operating Condition

Symbol	Description	Min	Typ	Max	Unit	Remark
VDD	Power supply Input voltage	**4.5**	**5.0**	**5.5**	[Volt]	
IDD	Power supply Input Current (RMS)	**-**	**1.1**	**1.3**	[A]	**VDD= 5.0V, All white Pattern, Fv=60Hz**
			1.2	**1.4**	[A]	**VDD= 5.0V, All white Pattern , Fv=75Hz**
PDD	VDD Power Consumption	**-**	**5.5**	**6.5**	[Watt]	**VDD= 5.0V, All white Pattern , Fv=60Hz**
			6.0	**7.0**	[Watt]	**VDD= 5.0V, All white Pattern , Fv=75Hz**
IRush	Inrush Current	**-**	**-**	**3.0**	[A]	***Note 3-1***
VDDrp	Allowable VDD Ripple Voltage	**-**	**-**	**500**	[mV]	**VDD= 5.0V, All white Pattern , Fv=75Hz**

Note 3-1: Inrush Current measurement:

Test circuit:

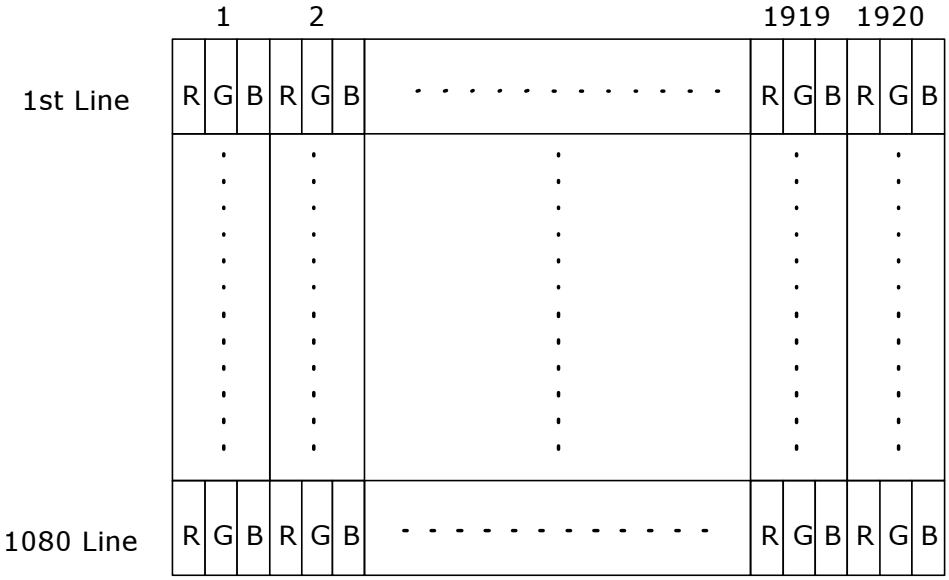




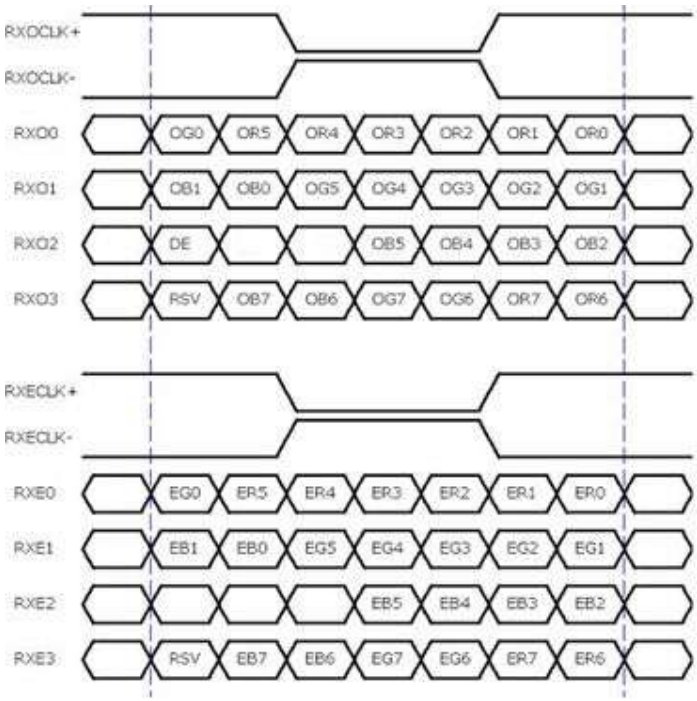
The duration of VDD rising time: 470us.

3.4 Signal Characteristics

3.4.1 LCD Pixel Format



3.4.2 LVDS Data Format



8 Bit Color Bit Order			
MSB	R7	G7	B7
	R6	G6	B6
	R5	G5	B5
	R4	G4	B4
	R3	G3	B3
	R2	G2	B2
	R1	G1	B1
LSB	R0	G0	B0

Note 3-2:

a. O = “Odd Pixel Data” E = “Even Pixel Data”

b. Refer to 3.4.1 LCD pixel format, the 1st data is 1 (Odd Pixel Data), the 2nd data is 2 (Even Pixel Data) and the last data is 1920 (Even Pixel Data).

3.4.3 Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

Color	Gray Level	Color Input Data																								Remark
		RED data (MSB:R7, LSB:R0)								GREEN data (MSB:G7, LSB:G0)								BLUE data (MSB:B7, LSB:B0)								
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	B3	B2	B1	B0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
Red	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Green	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
Blue	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	

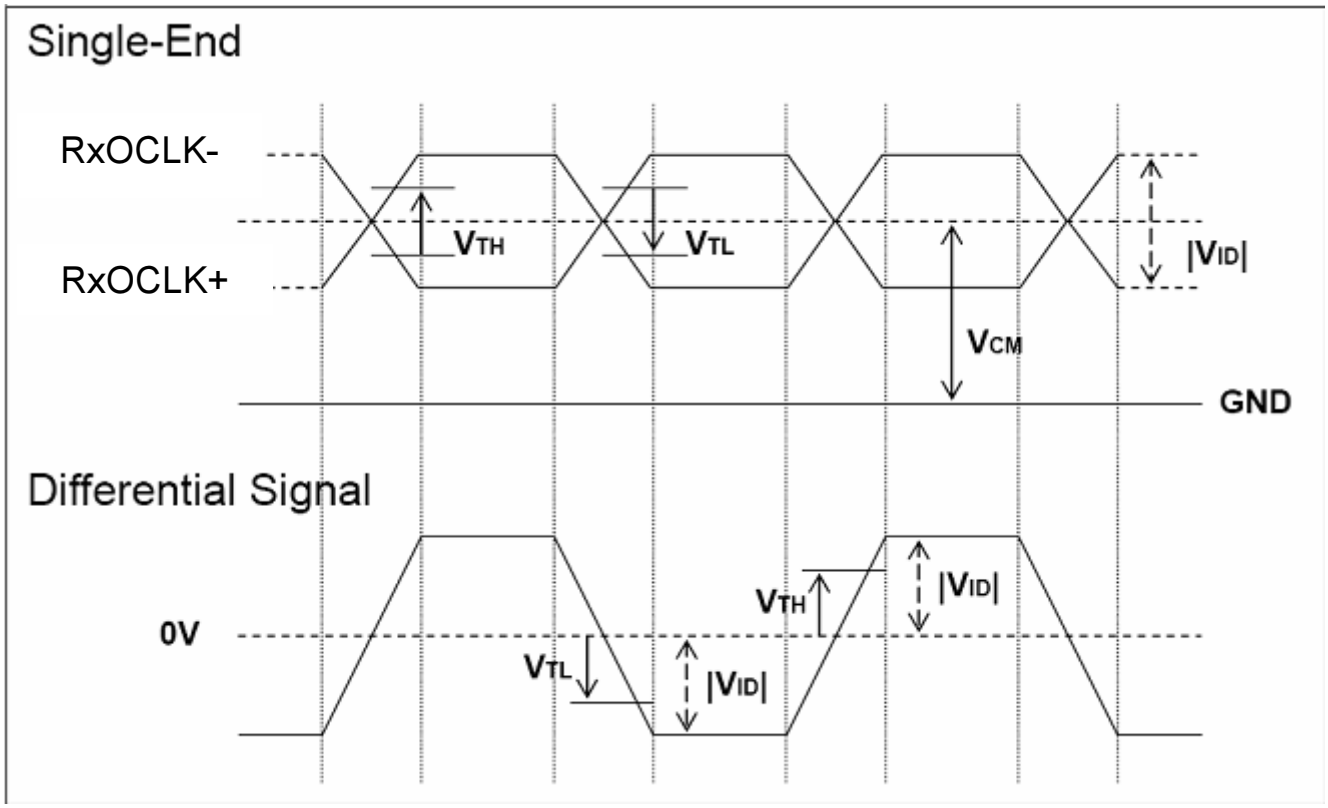
3.4.4 LVDS Specification

a. DC Characteristics:

Symbol	Description	Min	Typ	Max	Units	Condition
V_{TH}	LVDS Differential Input High Threshold	-	-	+100	[mV]	V_{CM} = 1.2V
V_{TL}	LVDS Differential Input Low Threshold	-100	-	-	[mV]	V_{CM} = 1.2V
$\lvert V_{ID} \rvert$	LVDS Differential Input Voltage	100	-	600	[mV]	
V_{CM}	LVDS Common Mode Voltage	+1.0	+1.2	+1.5	[V]	V_{TH}-V_{TL} = 200mV

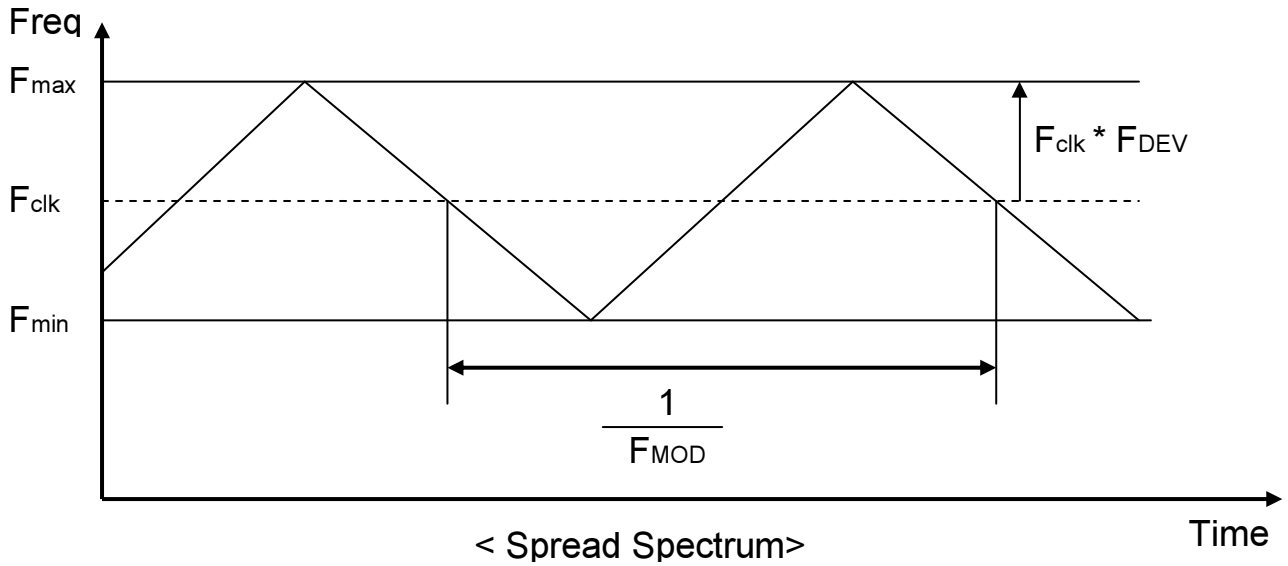
LVDS Signal Waveform:

Use RxOCLK- & RxOCLK+ as example.



b. AC Characteristics:

Symbol	Description	Min	Max	Unit	Remark
F_{DEV}	Maximum deviation of input clock frequency during Spread Spectrum	-	± 3	%	
F_{MOD}	Maximum modulation frequency of input clock during Spread Spectrum	-	200	KHz	



< Spread Spectrum>

Fclk: LVDS Clock Frequency

3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Description		Min.	Typ.	Max.	Unit	Remark
Tv	Vertical Section	Period	1092	1130	1793	Th	
Tdisp (v)		Active	1080	1080	1080	Th	
Tblk (v)		Blanking	12	50	713	Th	
Fv		Frequency	50	60	76	Hz	
Th	Horizontal Section	Period	1004	1050	1100	Tclk	
Tdisp (h)		Active	960	960	960	Tclk	
Tblk (h)		Blanking	44	90	140	Tclk	
Fh		Frequency	55	68	90	KHz	***Note 3-3***
Tclk	LVDS Clock	Period	11.1	14.0	18.2	ns	1/Fclk
Fclk		Frequency	54.8	71.2	90.0	MHz	***Note 3-4***

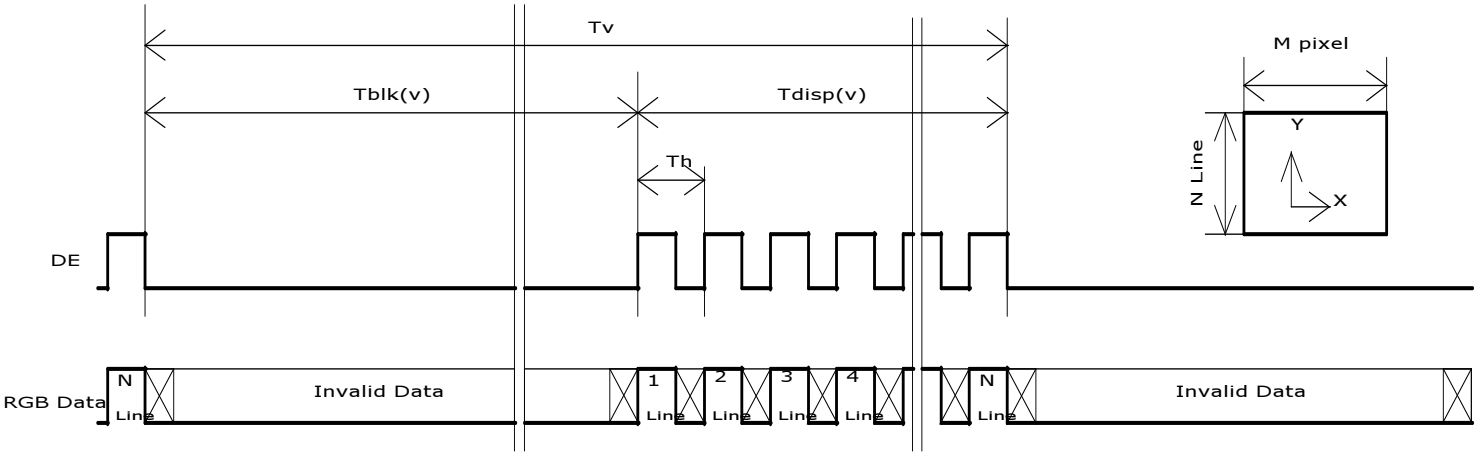
Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

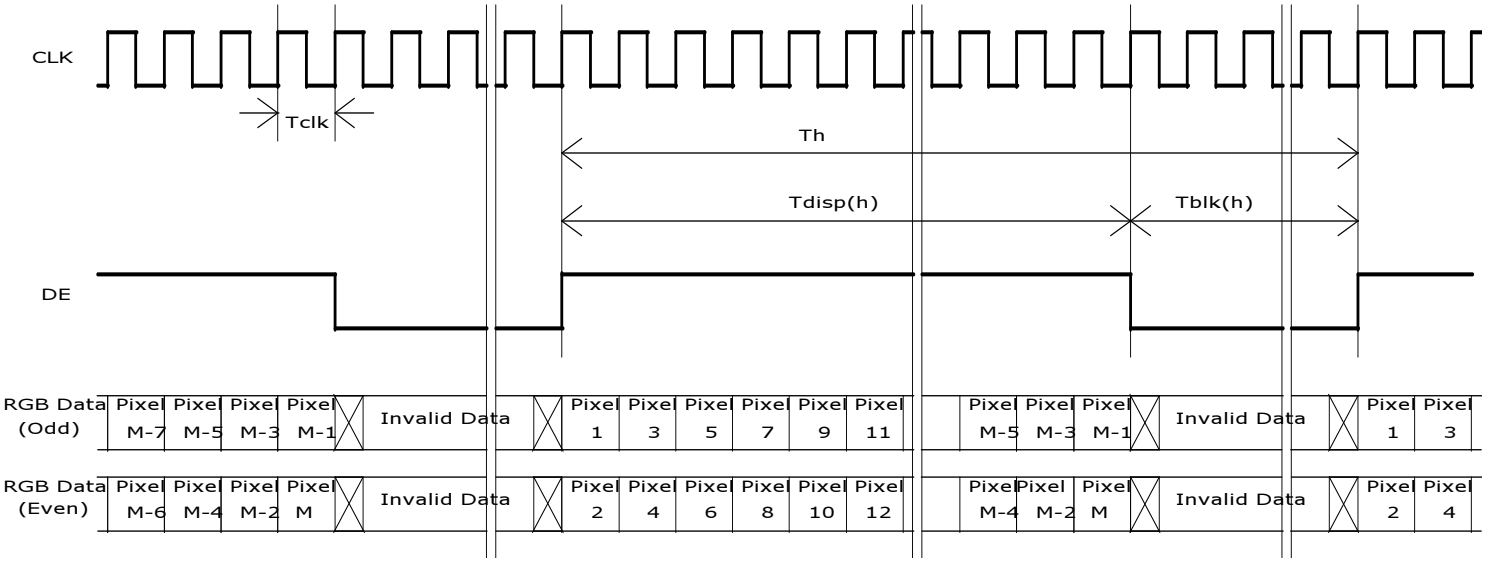
Fh (Min.) = Fclk (Min.) / Th (Min.);
Fh (Typ.) = Fclk (Typ.) / Th (Typ.);
Fh (Max.)= Fclk (Max.) / Th (Min.);

Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.

Fclk (Min.) = Fv (Min.) x Th (Min.) x Tv (Min.);
Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.);
Fclk (Max.) = Fv (Max.) x Th (Typ.) x Tv (Typ.);

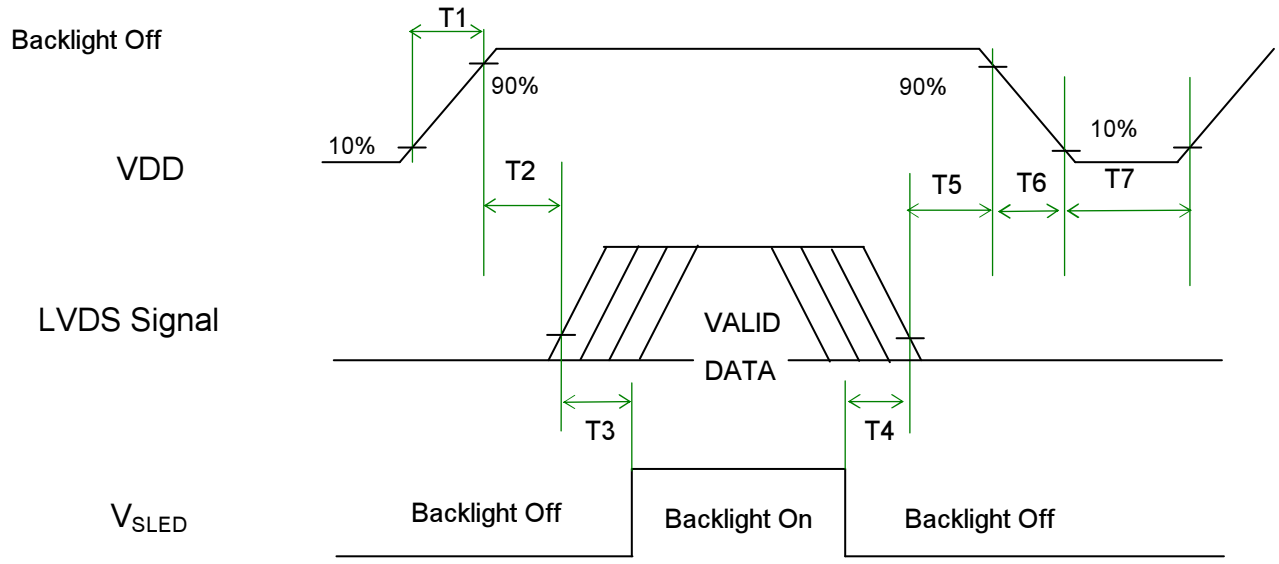
3.4.6 Input Timing Diagram





3.5 Power ON/OFF Sequence

VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Symbol	Value			Unit	Remark
	Min.	Typ.	Max.		
T1	0.5	-	10	[ms]	
T2	0	-	50	[ms]	
T3	500	-	-	[ms]	
T4	100	-	-	[ms]	
T5	0		50	[ms]	***Note 3-5*** ***Note 3-6***
T6	5	-	150	[ms]	***Note 3-6***
T7	1000	-	-	[ms]	

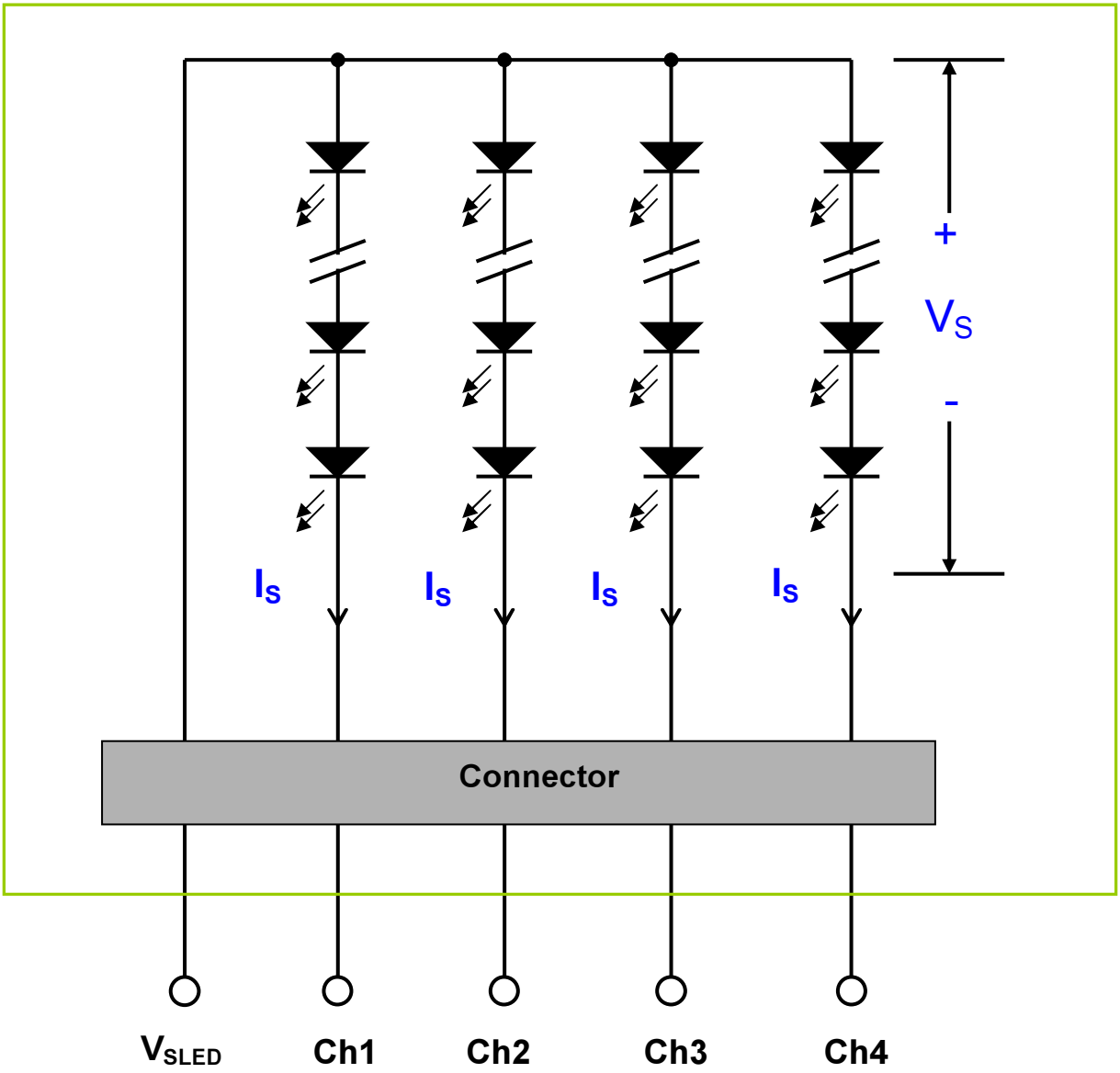
Note 3-5 : Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

Note 3-6 : During T5 and T6 period , please keep the level of input LVDS signals with Hi-Z state.

4 Backlight Unit

4.1 Block Diagram

The following shows the block diagram of the 24 inch Backlight Unit. And it includes 60 pcs LED in the LED light bar. (4 strings and 15 pcs LED of one string).



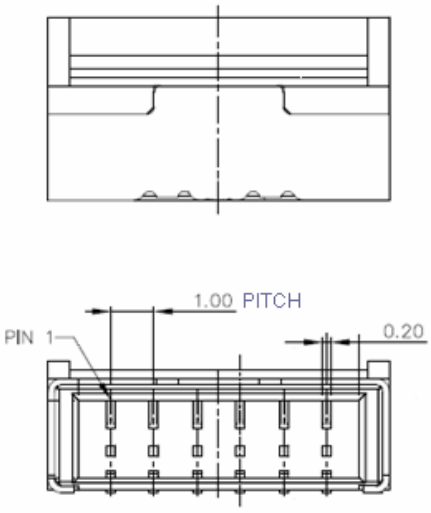
4.2 Interface Connection

4.2.1 Connector Type

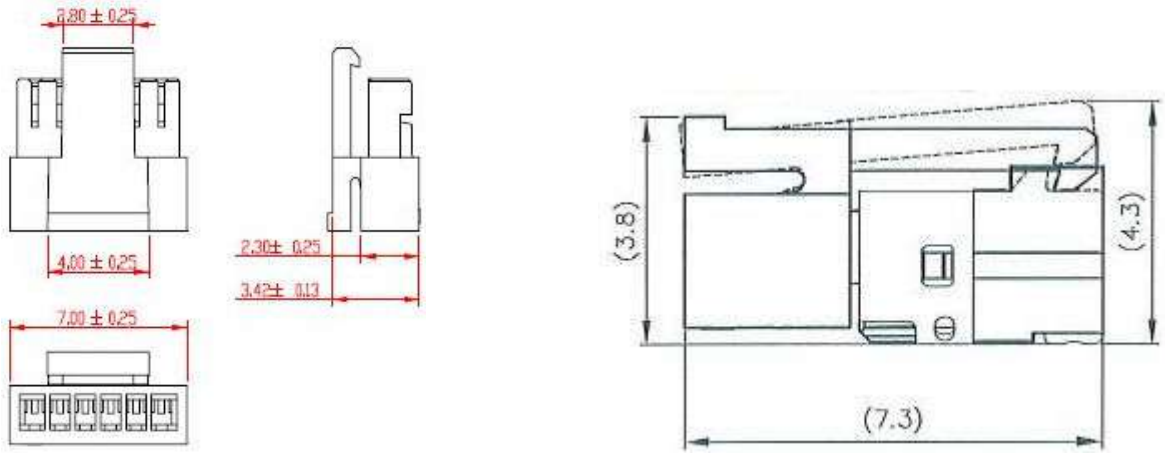
Backlight Connector	Manufacturer	**ENTERY**
	Part Number	**3707K-S06N-21R**
Mating Connector	Manufacturer	**ENTERY**
	Part Number	**H112K-P06N-00B (Non-Locking type)** **H112K-P06N-13B (Locking type)**

Backlight Connector dimension:

$H \times V \times D = 13.9 \times 3.00 \times 4.25, Pitch = 1.0(unit = mm)$

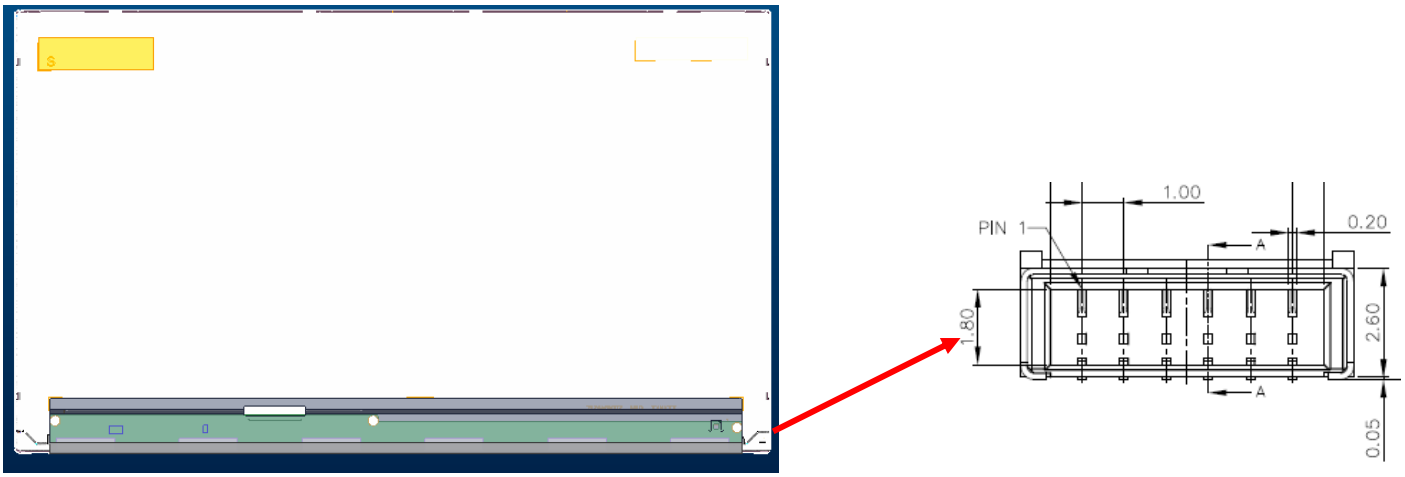


Mating Connector dimension:



4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	V_{SLED}	LED Power Supply Voltage Input Terminal	
4	V_{SLED}	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	



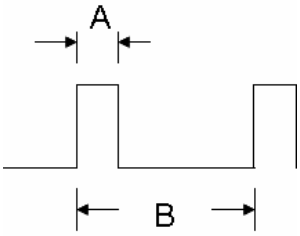
4.3 Electrical Characteristics

4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25℃)

Symbol	Description	Min	Max	Unit	Remark
Is	LED String Current	0	150	[mA]	100% duty ratio
			300	[mA]	*Duty ratio ≦ 10%* *Pulse time=10 ms*



Duty ratio= (A / B) X 100% ; (A: Pulse time, B: Period)

4.3.2 Recommended Operating Condition

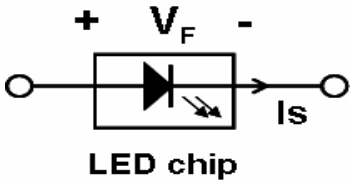
(Ta=25℃)

Symbol	Description	Min.	Typ.	Max.	Unit	Remark
Is	LED String Current	-	80	88	[mA]	100% duty ratio of LED chip
Vs	LED String Voltage	40.5	45	49.5	[Volt]	Is=80mA @ 100% duty ratio; ***Note 4-1***
ΔVs	Maximum Vs Voltage Deviation of light bar	-	-	3	[Volt]	Is=80mA @ 100% duty ratio; ***Note 4-2***
P_{BLU}	LED Light Bar Power Consumption	12.96	14.4	16.63	[Watt]	***Note 4-3***
LT_{LED}	LED Life Time	30,000	-	-	[Hour]	***Note 4-4***

Note 4-1: Vs (Typ.) = V_F (Typ.) X LED No. (**one string**);

a. V_F: LED chip forward voltage, V_F (Min.)=**2.7V**, V_F(Typ.)=**3.0V**, V_F(Max.)=**3.3 V**

b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V_F (Min.) & V_F(Max.);



Note 4-2: ΔVs (Max.) = ΔV_F X LED No. (one string);

a. ΔV_F: LED chip forward voltage deviation; (**0.2 V** , each Bin of LED V_F)

Note 4-3: P_{BLU} (Typ.) = Vs (Typ.) X Is (Typ.) X **4 ; (4** is total String No. of LED Light bar)

P_{BLU} (Max.) = Vs (Max.) X Is (Max.) X **4** ;

Note 4-4: Definition of life time:

a. Brightness of LED becomes to 50% of its original value

b. Test condition: Is = **80mA** and 25℃ (Room Temperature)

5 Reliability Test

AUO reliability test items are listed as following table. (*Bare Panel only*)

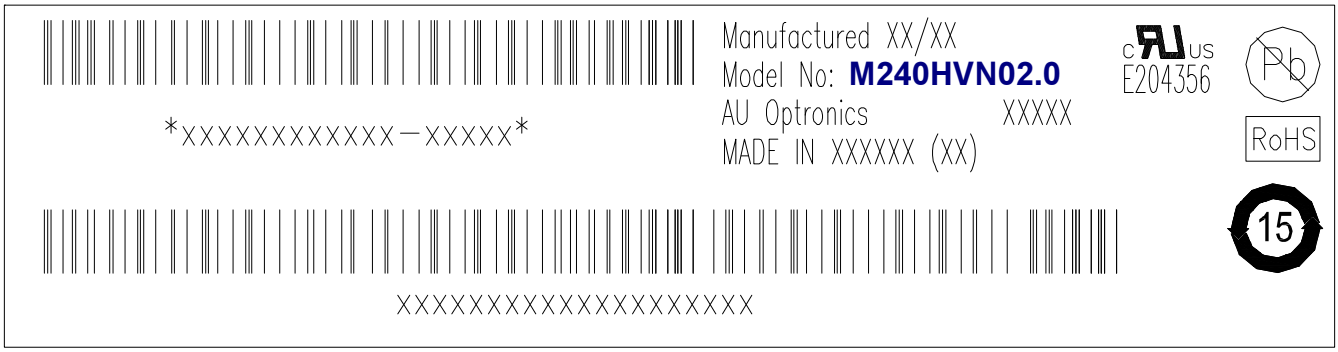
Items	Condition	Remark
Temperature Humidity Bias (THB)	Ta= 50□, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50□, 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= 0□, 300hours	
High Temperature Storage (HTS)	Ta= 60□, 300hours	
Low Temperature Storage (LTS)	Ta= -20□, 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)	
Drop Test	Height: **46** cm, package test	
Thermal Shock Test (TST)	-20□/30min, 60□/30min, 100 cycles	***Note 5-1***
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 15KV, 150pF(330Ω) 1sec, 8 points, 25 times/ point.	***Note 5-2***
	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 8 points, 25 times/ point.	
Altitude Test	Operation:18,000 ft Non-Operation:40,000 ft	

Note 5-1: a. A cycle of rapid temperature change consists of varying the temperature from -20□ to 60□, and back again. Power is not applied during the test.
b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed
No data lost
Self-recoverable
No hardware failures.

6 Shipping Label

The label is on the panel as shown below:



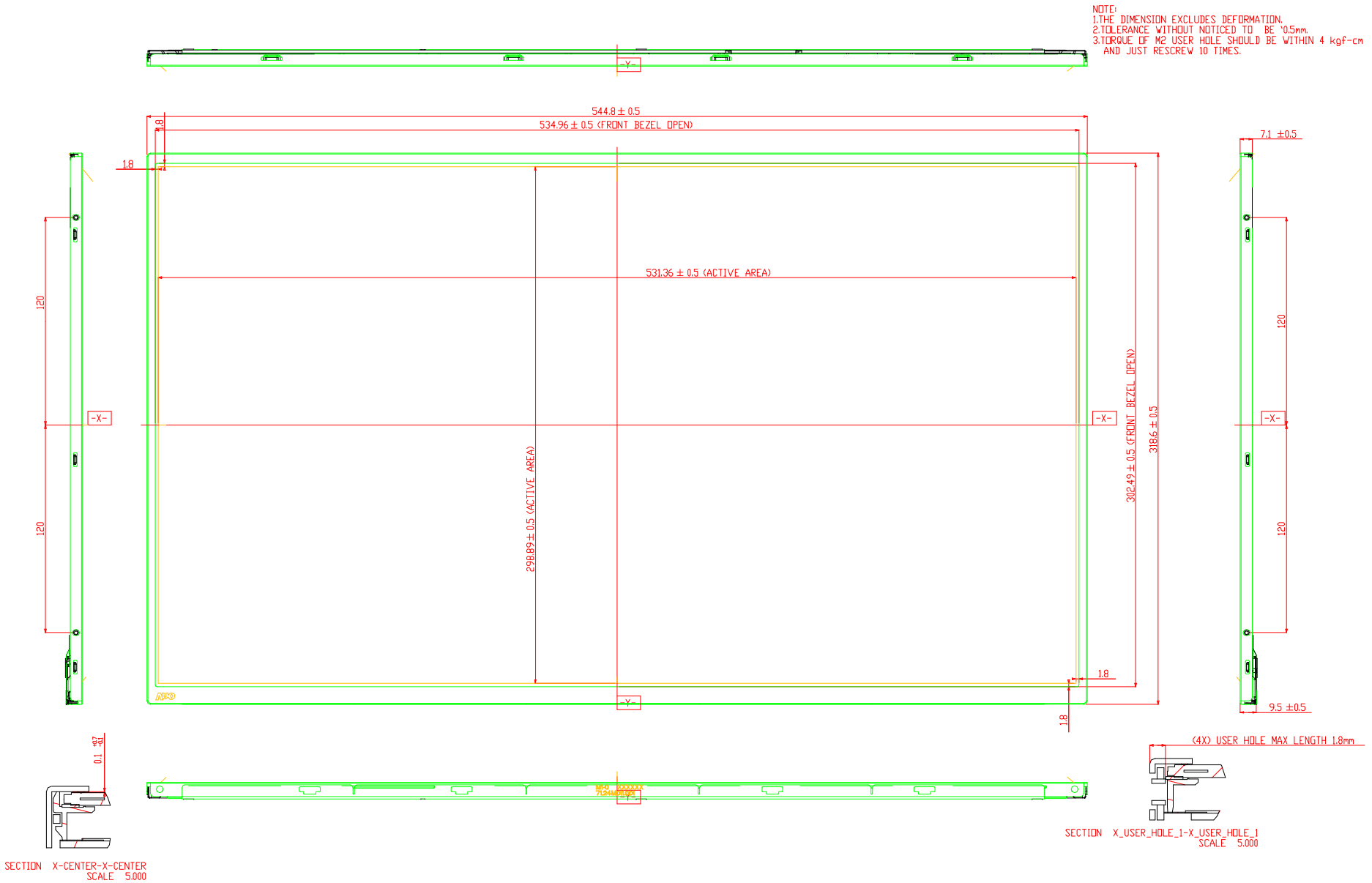
Note 6-1: For Pb Free products, AUO will add for identification.

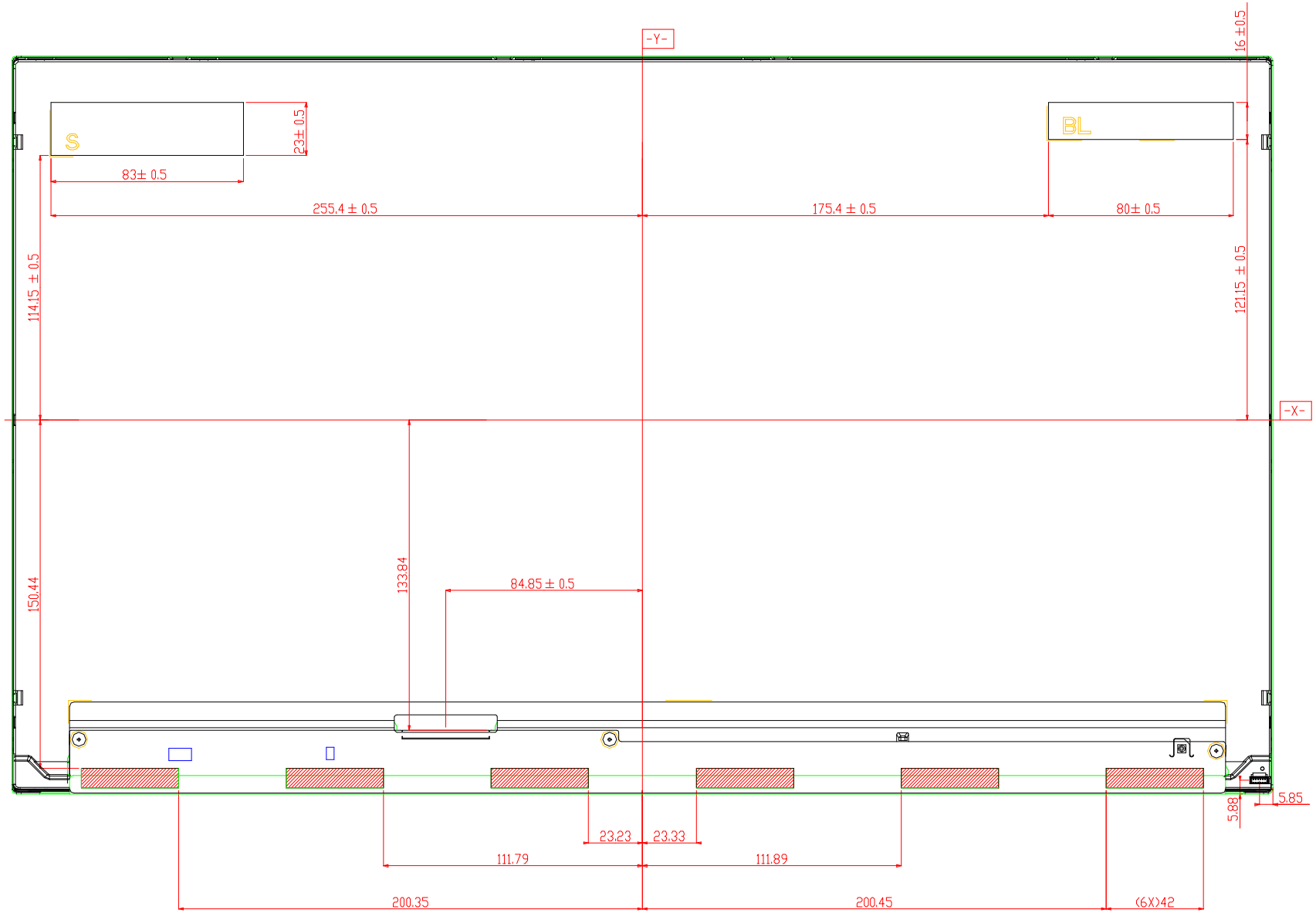
Note 6-2: For RoHS compatible products, AUO will add for identification.

Note 6-3: For China RoHS compatible products, AUO will add for identification.

Note 6-4: The Green Mark will be presented only when the green documents have been ready by AUO Internal Green Team.

7 Mechanical Characteristics

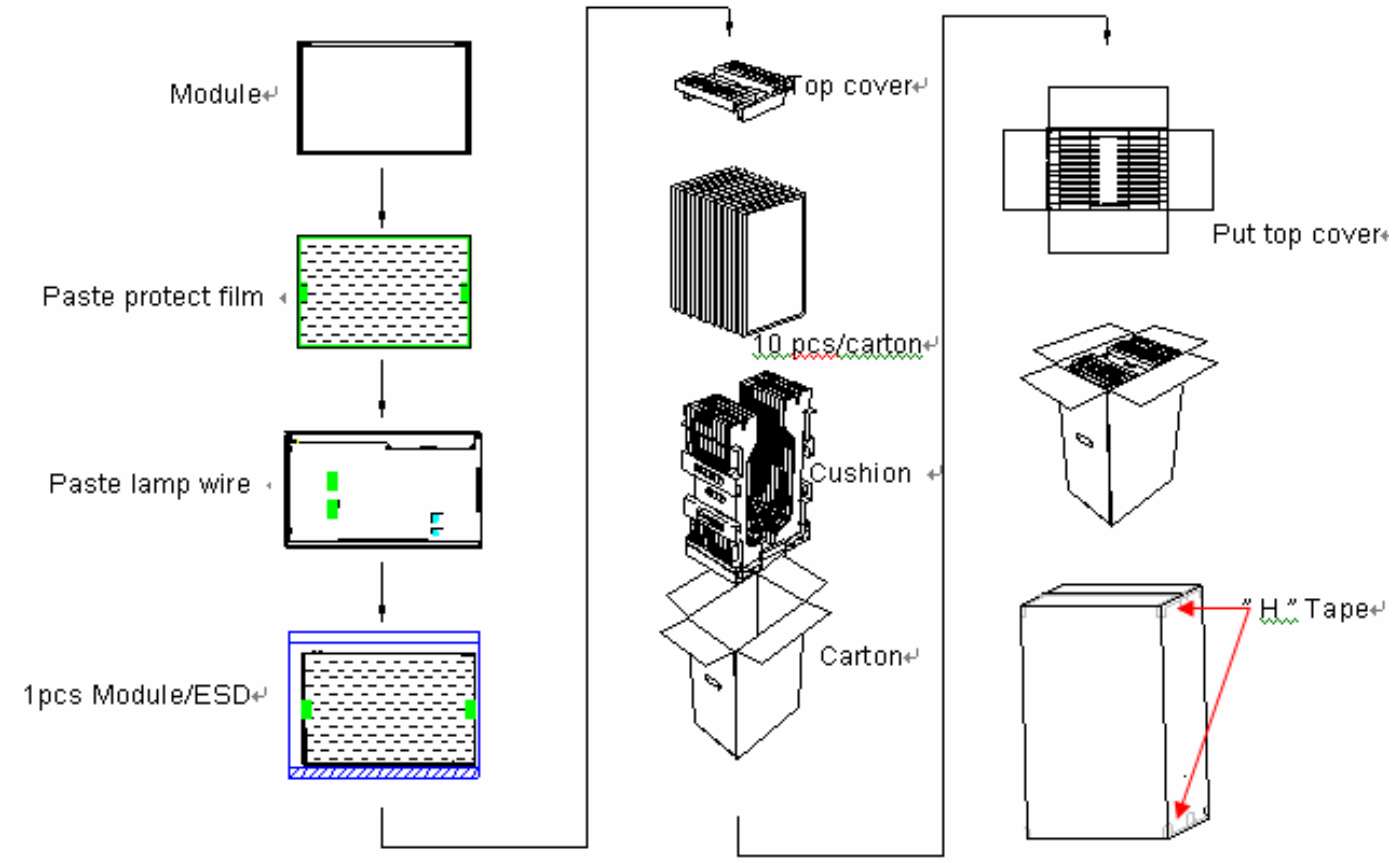


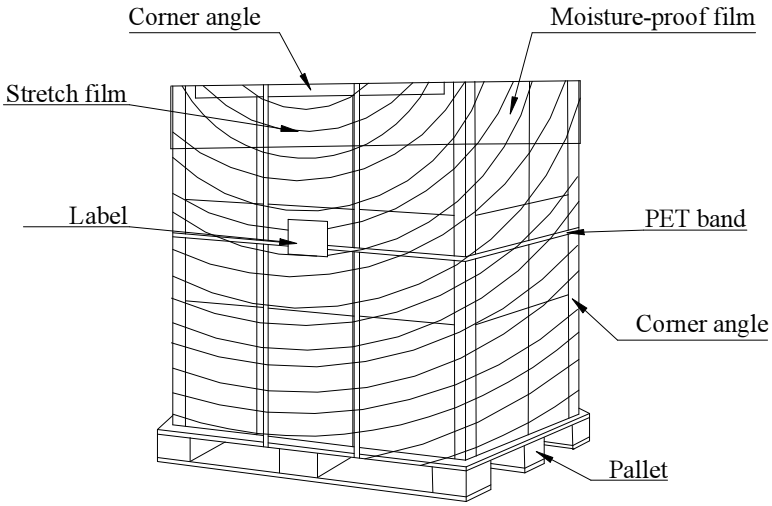


Avoid touching COF position when doing mechanical design

8 Packing Specification

8.1 Packing Flow





8.2 Pallet and shipment information

Item	Specification			Remark
	Q'ty	Dimension	Weight(kg)	
Panel	1	544.8 (H) x 318.6 (V) x 9.5 (D)	1.625	
Cushion	1	-	1.7	
Box	1	406(L)mm x 281(W)mm x 651(H)mm	1.2	without Panel & cushion
Packing Box	10 pcs/Box	406(L)mm x 281(W)mm x 651(H)mm	19.15	with panel & cushion
Pallet	1	1150(L)mm x 840(W)mm x 132(H)mm	12.00	
Pallet after Packing	16 boxes/pallet	1150(L)mm x 840(W)mm x 1434(H)mm	318.4	